

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT7366623

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YOUNG WOO LEE	06/15/2017
JAE UNG LEE	06/15/2017
BYONG JIN KIM	06/15/2017
EUNNARA CHO	06/15/2017
JI HOON OH	06/15/2017
YOUNG SEOK KIM	06/15/2017
JIN YOUNG KHIM	06/15/2017
TAE KYEONG HWANG	06/15/2017
JIN SEONG KIM	06/20/2017
GI JUNG KIM	06/20/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	AMKOR TECHNOLOGY, INC.
<b>Street Address:</b>	2045 E. TECHNOLOGY CIRCLE
<b>City:</b>	TEMPE
<b>State/Country:</b>	ARIZONA
<b>Postal Code:</b>	85284
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17832952
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	6023262244
<b>Email:</b>	KEVIN@KJACKSONIPLAW.COM
<b>Correspondent Name:</b>	LAW OFFICE OF KEVIN B JACKSON
<b>Address Line 1:</b>	6315 E CACTUS WREN RD
<b>Address Line 4:</b>	PARADISE VALLEY, ARIZONA 85253-8006
<b>ATTORNEY DOCKET NUMBER:</b>	JK-027-2D

<b>NAME OF SUBMITTER:</b>	KEVIN B. JACKSON
<b>SIGNATURE:</b>	/KEVIN B. JACKSON/
<b>DATE SIGNED:</b>	06/06/2022
<b>Total Attachments: 3</b> source=JK-027_Assignment_File#page1.tif source=JK-027_Assignment_File#page2.tif source=JK-027_Assignment_File#page3.tif	

## ASSIGNMENT & AGREEMENT

JK-027

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Young Woo Lee	of Gyeonggi-do, Republic of Korea
Jae Ung Lee	of Seoul, Republic of Korea
Byong Jin Kim	of Gyeonggi-do, Republic of Korea
EunNaRa Cho	of Incheon-si, Republic of Korea
Ji Hoon Oh	of Gyeonggi-do, Republic of Korea
Young Seok Kim	of Seoul, Republic of Korea
Jin Young Khim	of Seoul, Republic of Korea
Tae Kyeong Hwang	of Seoul, Republic of Korea
Jin Seong Kim	of Chandler, Arizona, U.S.A.
Gi Jung Kim	of Phoenix, Arizona, U.S.A.

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Amkor Technology, Inc. ("AMKOR") a Delaware corporation, having place of business at 2045 E. Innovation Circle, City of Tempe, State of Arizona, 85284, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

### **SEMICONDUCTOR DEVICE HAVING EMI SHIELDING STRUCTURE AND RELATED METHODS**

Attorney Docket No. JK-027; Amkor Ref: 16100049-17030042-IP-1355-US

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

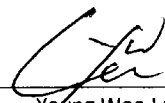
We hereby also sell, assign, and transfer unto AMKOR, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize AMKOR to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to AMKOR, for the sole use and behalf of AMKOR, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to AMKOR.

We agree that, when requested, we will, without charge to AMKOR, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in AMKOR, its successors, assigns, and legal representatives or nominees.

We covenant with AMKOR, its successors, assigns, and legal representatives that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

Executed this 15 day of June, 2017



Young Woo Lee  
(Full Name)

ASSIGNMENT & AGREEMENT

JK-027

Amkor Ref: 16100049-17030042-IP-1355-US

Assignment & Agreement (Continued)

Executed this 15 day of June, 2017



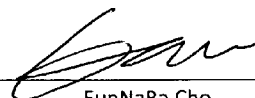
Jae Ung Lee  
(Full Name)

Executed this 15 day of June, 2017



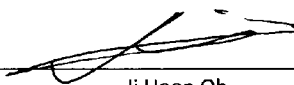
Byong Jin Kim  
(Full Name)

Executed this 15 day of June, 2017



EunNaRa Cho  
(Full Name)

Executed this 15 day of June, 2017



Ji Hoon Oh  
(Full Name)

Executed this 15 day of June, 2017



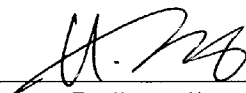
Young Seok Kim  
(Full Name)

Executed this 15 day of June, 2017



Jin Young Khim  
(Full Name)

Executed this 15 day of June, 2017



Tae Kyeong Hwang  
(Full Name)

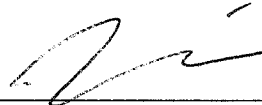
ASSIGNMENT & AGREEMENT

JK-027

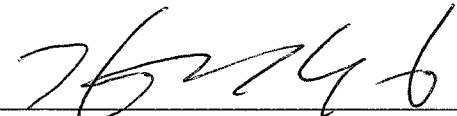
Amkor Ref: 16100049-17030042-IP-1355-US

Assignment & Agreement (Continued)

Executed this 20<sup>th</sup> day of June, 2017

  
\_\_\_\_\_  
Jin Seong Kim  
(Full Name)

Executed this 20<sup>th</sup> day of June, 2017

  
\_\_\_\_\_  
Gi Jung Kim  
(Full Name)

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